
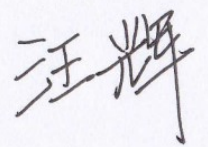



SPECIFICATION



| | |
|--------------------|--|
| <i>Device Name</i> | |
| <i>Part No.</i> | |
| <i>Customer</i> | |
| <i>Date</i> | |

| Customer Confirm | Approved by | Checked by | Issued by |
|------------------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| |  |  |  |

LED Display

(9.2mm(0.36'') Seven Segments Tripple Digit)

| Part No. | Common Cathode | | Common Anode | |
|------------------|----------------|--------------------|---------------|--------------------|
| | | <i>YDUG-3036KM</i> | | <i>YDUG-3036AM</i> |
| Dice Color | Chip Material | Color of Segment | Surface Color | |
| High Super Green | AlGaInP | White Diffused | Black | |

1. Features

High efficiency, low power consumption.

Extremely low current.

Luminous evenly distributed on each segment.

Low development cost.

This product doesn't contain restriction Substance comply RoHS Standard.

2. Descriptions

Industrial standard size.

These display provide excellent reliability in bright ambient light.

These devices are made with white segments and black surface.

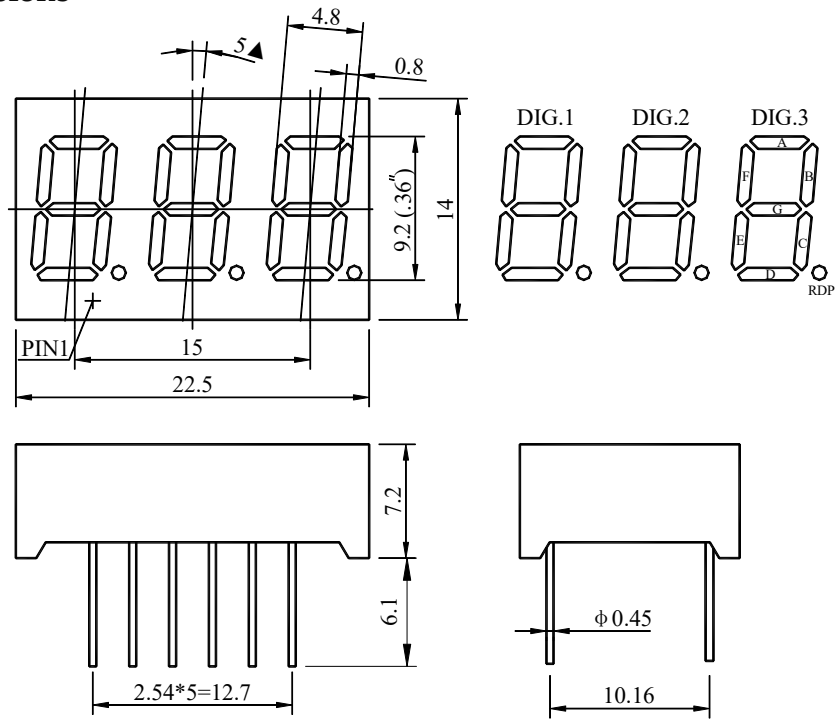
3. Applications

Audio equipment or Instrument panels.

General use for digital indicators.

Multimedia product.

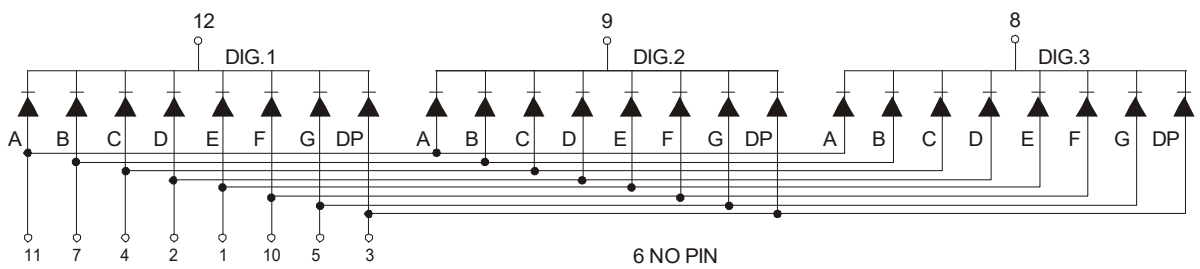
4. Package Dimensions



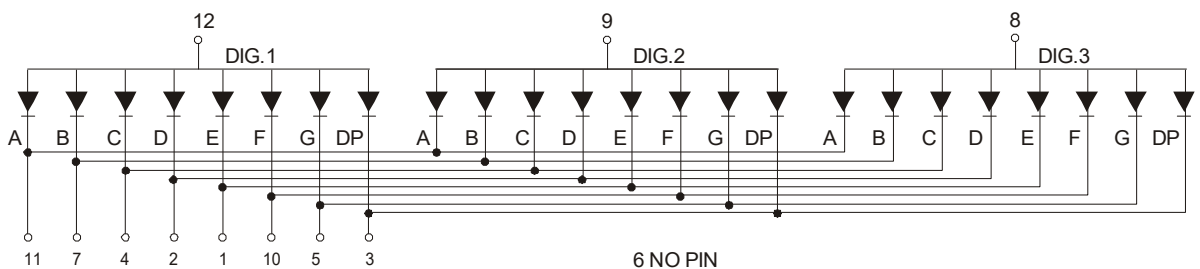
Note :

1. All dimensions are in millimeters(mm)
2. Tolerance is $\pm 0.25\text{mm}$ unless otherwise noted
3. Protruded resin under flange is 1.5mm Max LED.

5. Internal Circuit Diagram



YDUG-3036KM (Common Cathode)



YDUG-3036AM (Common Anode)

6. Absolute Maximum Rating (Ta = 25 °C)

| Parameter | Symbol | Maximum Rating | Unit |
|----------------------------------------------|------------------|----------------|------|
| Power Dissipation/seg. | P _M | 70 | mW |
| Peak Forward Current /seg. (Duty 1/10@ 1KHz) | I _{FP} | 80 | mA |
| Continuous Forward Current/seg. | I _F | 20 | mA |
| Recommend Use Current/seg. | I _F | 5 ~ 10 | mA |
| Reverse Voltage | V _R | 6 | V |
| Operation Temperature | T _{opr} | -35 °C ~ 80 °C | °C |
| Storage Temperature | T _{stg} | -40 °C ~ 85 °C | °C |
| Soldering Temperature (time≤5 seconds.) | T _{sol} | 260±5 | °C |

Note : 1. This is the limit current . It is not allowed to use when the product work continuously.

2. It is recommended that the product is driven by TTL,CMOS.

3. Soldering time≤5 seconds.

7. Electron-Optical Characteristics (Ta = 25 °C)

| Parameter | Symbol | Typ. | Max. | Unit | Test Condition |
|--------------------------|----------------|------|------|------|-----------------------|
| Luminous Intensity/seg. | I _v | 2.8 | | mcd | I _F =10 mA |
| Forward Voltage/seg. | V _F | 2.0 | 2.5 | V | I _F =20 mA |
| Reverse Current/seg. | I _R | | 50 | μA | V _R =6V |
| Peak Wavelength | λ _p | 570 | | nm | I _F =20 mA |
| Spectral Line Half Width | Δλ | 10 | | nm | I _F =20 mA |

8. Reliability

1) Test Items and Conditions

| No. | Test Item | Test Conditions | Sample | Ac/Re |
|-----|------------------------------------------|-----------------------------------------------------------------------------------------------------|--------|-------|
| 1. | Temperature Cycle | -40 ±5 °C → 25 ±5 °C → 85 ±5 °C → 25 ±5 °C (30min, 5min, 30min, 5min) 20 Cycles | 20 | 0/1 |
| 2. | High Temperature Storage | Ta : 100 ±5 °C Test time = 1,000 hrs. (-24 hrs., +72 hrs.) | 20 | 0/1 |
| 3. | High Temperature & High Humidity Working | Ta : 85±5 °C, RH : 85±5%, If = 10mA/seg. Test time = 500 hrs. (-24 hrs., +72 hrs.) | 20 | 0/1 |
| 4. | Low Temperature Storage | Ta : -40±5 °C Test time = 1,000 hrs. (-24 hrs., +72 hrs.) | 20 | 0/1 |
| 5. | Operating Life Test | Connect with a power If = 10mA/seg. Ta = 25 ±5 °C Test time = 1,000 hrs. (-24 hrs., +72 hrs.) | 20 | 0/1 |
| 6. | Solder Resistance | T.sol = 260 ±5 °C one time Dwell Time = 5 ±1sec., distance 3mm | 20 | 0/1 |
| 7. | Thermal Shock | -40 ±5 °C → 85 ±5 °C (15min, 15min) 20Cycles | 20 | 0/1 |

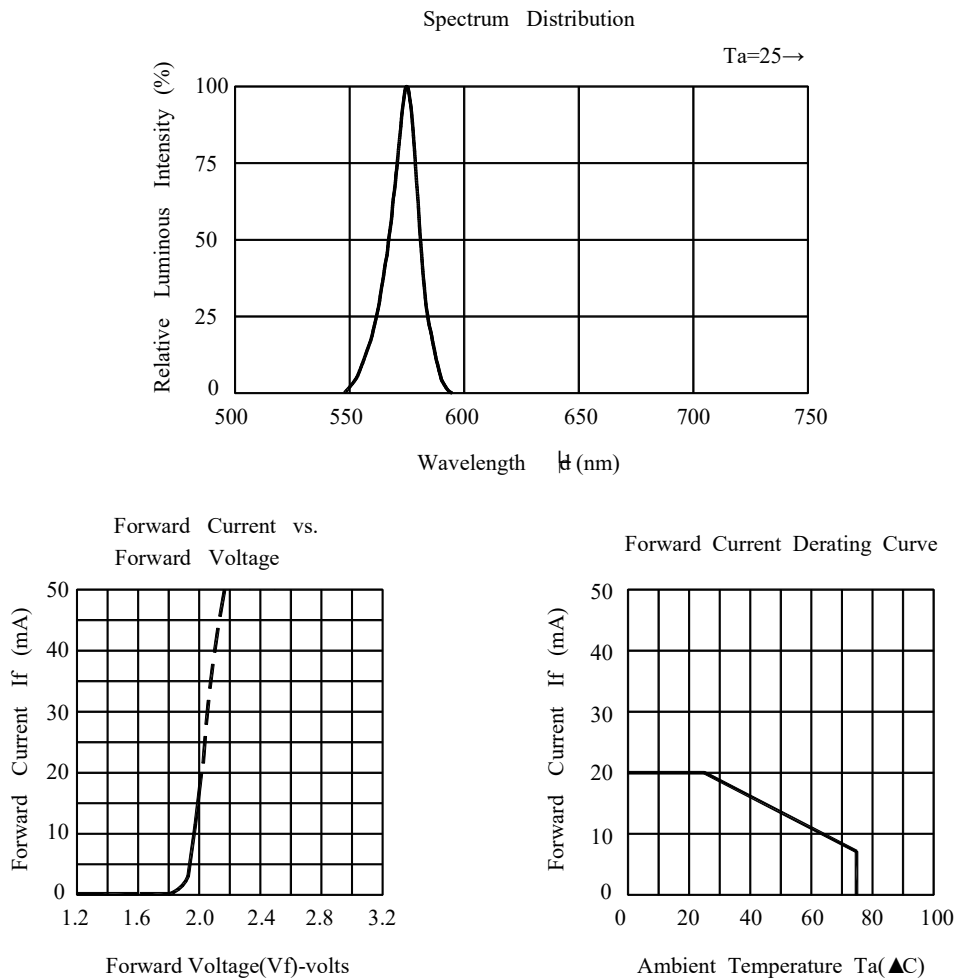
2) Criteria of judging the damage

| Item | Symbol | Test condition | Criteria for judgement | |
|--------------------|--------|----------------|------------------------|-----------|
| | | | Min. | Max. |
| Forward voltage | VF | If = 10mA/Seg. | / | U.S.L*1.1 |
| Reverse current | IR | VR=5V | / | 15uA |
| Luminous intensity | IV | If = 10mA/Seg. | L.S.L*0.7 | / |
| Wave length | λD/λP | If = 10mA/Seg. | / | U.S.L±2nm |
| Appearance | / | View check | No mechanical damage | |

* U.S.L: Upper standard level

L.S.L: Lower standard level

9. Typical Characteristic



10. Storage and application notices

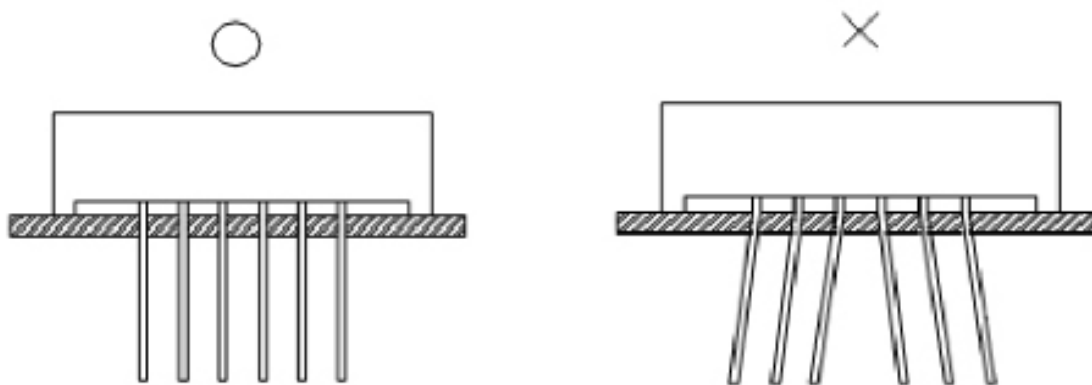
10-1. Storage

- 1) Before opening package : the LEDs should be kept at 18~30°C, related humidity : 30~70% RH. They should be used out within 3 months.
- 2) LEDs should be used out within 24 hrs. after opening package to avoid the lead frame's corrode.
- 3) The internal box can not be contacted with ground to prevent absorption of moisture
- 4) No acid, alkali, salt, corrosive and explosive gas; away from sunlight and keep the environment clean.

10-2. Application

- 1) Do not use any unknown chemical liquid to clean LED, it will damage the LED resin surface, use the alcohol under the room temperature if necessary but less than 1 min.

- 2) When forming lead frame, the lead frame should be bent at a point at least 2mm from the base of epoxy. The forming should be done before soldering which can avoid epoxy's broken and internal structure's damage. Forming must be operated by the specific jig or the qualified operator to make sure the lead frame and distance are as same as the circuit board. Specific is shown as below.



Mark : "o" means correct, "x" means incorrect.

- 3) Do not apply any bending stress to the surface of the LED. The stress to the surface may damage the surface ink color and internal connection which causes the electric character & appearance's failure.
- 4) Soldering
- Soldering iron power : under 30W, Soldering temperature : $295 \pm 55^{\circ}\text{C}$,
Soldering time : within 3 sec.(only 1time)
 - Soldering temperature in solder machine : $250 \pm 10^{\circ}\text{C}$, Soldering time : within 5sec.
 - Soldering temperature during wave soldering process : $230 \pm 10^{\circ}\text{C}$,
Soldering time : within 5sec.
- 5) The LEDs should be soldered at the coordinated position on the PCB, the distance from soldering point to epoxy resin should be 3mm at least. If the 2nd soldering process required, 3 min. must be left to ensure the high temperature status can return to room temperature. But the recommended soldering time is only 1time in principle.
- 6) If solder the LEDs on one PCB by the soldering iron; do not solder the different lead frames of one LED, but solder in proper sequence.

7) Note of Electrical matter :

- ① One-way conduction, LED does not allow the reverse driving
- ②
 - a. LED is a kind of constant current component which can not be lighted by the constant voltage mode, a smaller voltage fluctuation can cause the large current fluctuation which causes the failure of LED
 - b. Each LED should be drove under constant current mode if in a parallel circuit design, otherwise, the colour and brightness will be non-uniform.
 - c. When the environmental temperature rising, the LED junction temperature will rise, internal resistance will decrease, so the current will be increased by the constant voltage power which short the life span.
- ③ If the brightness of lighting source can meet the requirement, we recommend using the driving current less than the rated current, in order to improve the product's reliability.

8) LED is a kind of electrostatic sensitive devises, anti-static measures have to be processed during storage and operation

- ① LED production workshop should lay anti-static floor and ground connection, the work table have to use the anti-static materials and cover a table mater with the surface resistance of 10^6 - $10^9\Omega$
- ② Production machine: REFLOW, SMT equipment, electric iron, test equipment; all the equipments must be well grounded, and the grounding alternating current impedance should be less than 1.0Ω . A fan need to be installed on the equipments and production processes that easy to generate static electricity, the operators must wear anti-static clothing, shoes, wristband, and gloves, etc. in the process.
- ③ LEDs must be contained in the anti-static box, and all the package material should be the anti-static materials.

9) The details electronic characters can refer to our product specification.

11. Notes

- 11-1. Above specification may be changed without notice. We will reserve authority on material change for above specification.
- 11-2. When use this product, please observe the absolute maximum ratings and the instructions for the specification sheets. We assume no responsibility for any damage resulting from using of the product which does not comply with the instructions included in the specification sheets.